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# Predicting Low Toxicity and Scalable Solvent Systems for High-Speed Roll-to-Roll Perovskite Manufacturing

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Printed lead-based perovskite photovoltaics (PV) have gained interest due to their potential to be manufactured with scalable roll-to-roll techniques. In industrial scaleup, toxicity of inks can constrain roll-to-roll manufacturing due to the added cost of managing toxic effluents. Due to solvent toxicity, few perovskite solution chemistries in published works are scalable to gigawatt production capacity at low cost. Herein, it is shown that for scalable PV production, the use of aprotic polar solvents should be avoided due to their overall toxicity. Compliance with worldwide worker safety regulations for solvent exposure limits could require additional air handling requirements for some solvents, which in turn would affect cost-effectiveness. It is shown that costs associated with handling of hazardous substances can be significant and estimate an added cost of ¢3.7/W for dimethylformamide (DMF)-based inks. To solve this problem, a new perovskite ink solvent system is developed that is composed entirely of ether and alcohol, which has an effective exposure limit 14 $\times$ higher than DMF, making it suitable for industrial coating processes. It is shown that the new ink solvent system is capable of fabricating high-efficiency perovskite solar cells processed in 1 min on a standard roll-to-roll system.

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# **Broader Impact**

This manuscript introduces solvent toxicity in solar perovskite ink chemistries as a major technoeconomic limitation for the growth of the technology. More specifically, the capital and operational cost of handling such toxic chemicals to maintain a safe working environment can lead to significant added costs. As all record power conversion efficiency (PCE) devices to date have been solution processed, this represents a major challenge for the perovskite optoelectronic field and of printed electronics as a whole. Knowing this limitation, we propose that solvent selections for ink chemistries should be more quantitative and focus on lowering toxicity. To this end, we show that a Hansen solubility model is effective in predicting ink systems using lower toxicity solvents. We also show that inks formed from this method are applicable for high-speed slot-

die coating, limiting the need for long anneal times. These methods and results demonstrate a useful framework for quantitatively engineering solvent systems with reduced toxicity while simultaneously maintaining and surpassing performance. It, therefore, provides a pathway and major step forward toward the commercialization of solution-coated perovskite technologies.

#### 1. Introduction

The performance of photovoltaic (PV) structures made from solution-processed lead-halide perovskites recently exceeded 25% PCE,<sup>[1]</sup> raising the interest in printing and coating deposition techniques for the scale-up production of this solar technology. With scale-up, toxicity of production needs to be examined, however, there is presently little information and safety guidelines for perovskite thin films in a manufacturing setting. For example, toxicity of lead in perovskite thin films<sup>[2–6]</sup> has led to a growing number of publications examining lead-free perovskites,<sup>[5]</sup> however, there has been limited work on the toxicity of perovskite ink systems on a whole. Most studies focus on the use of green solvents for minimal environmental impact rather than focusing on how toxicity impacts local manufacturing and the local workforce.<sup>[7–9]</sup> These ink systems are composed of solvents,<sup>[10–15]</sup> processing additives,<sup>[16,17]</sup> and organic and

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metallic salts<sup>[18]</sup> all of which have different effects on the human body. <sup>[3]</sup> The ink solvents, as the majority component of inks, have the largest potential for health impact during the perovskite film processing, directing us to focus the present study to identifying less-toxic solvent compositions. Indeed, toxic chemicals and solvents have been readily used in industrial semiconductor processing with well-known negative health effects, <sup>[19–23]</sup> so we will use the present study to generalize the perovskite ink solvent selection framework, quantifying the effects of toxicity in perovskite thin-film manufacturing processes. We develop a set of selection rules that leads us to formulate a less toxic, fast crystalizing perovskite ink for use in slot die coating applications.

#### 1.1. Toxicity in Manufacturing

Chemical toxicity can be quantified with several methods, but the most well understood metric is through the lethal dosing of 50% of a studied population (LD50). A LD50 study is conducted by subjecting test animals (usually rats, rabbits, or guinea pigs) to a chemical of interest. [24–26] An analog for volatile compounds is the lethal concentration to 50% of the population (LC50). These tests are nonstandardized, with dosage timing and methodology being dependent on each specific study. Therefore, LD50 and LC50 are particularly useful for understanding acute toxicity, rather than longer-term chronic effects.

In the thin-film coating industry, workers may be exposed to solvents during their working shift over the course of years. [27] For them, LD50 and LC50 are incomplete metrics for understanding if a solvent is safe to use industrially. Instead, in the present study, we use government-regulated work exposure limits, which dictate the maximum chemical concentration a worker is allowed to be exposed to before deemed unsafe. Lower exposure limits correlate to a higher toxicity. We use these limits in combination with practical constraints present in industrial settings to determine solvent selection rules for coating inks.

## 2. Discussion

In the USA, solvent exposure in industrial settings are regulated federally through the Occupational Safety and Health Administration (OSHA). [28] OSHA regulates permissible exposure limits (PELs) as well as ventilation requirements in hazardous areas that could expose a worker to toxic or flammable fumes. Regulations are based on academic studies, historical and medical effects on workers, [27] industry voices and recommendations from the National Institute of Occupational Safety and Health, who generate Recommended Exposure Limits (RELs). [29] There are many other third-party institutions, such as the American Industrial Hygiene Association (AIHA) and the American Conference of Governmental Industrial Hygienists (ACGIH) who recommend chemical limits such as Threshold Limit Values (TLVs). [30] In Europe, the European Agency for Safety and Health at Work (EU OSHA) also regulates the use of solvents in the European Union as Occupational Exposure Limits (OELs).[31] Many countries have adopted or have similar exposure limits to the institutions previously mentioned. For the purpose of this discussion, focus will be placed on U.S. regulatory practices due to regulations being largely federal in nature, ease of access to databases, and exposure limits being similar country to country. A list of U.S. OSHA standards that apply to the coating industry can be seen in Table S1, Supporting Information. A list of common solvents used in perovskite-based thin-film research, along with their exposure limits are seen in **Table 1**. We also include 25% of the lower explosion limit (LEL) as a useful metric of comparison. This limit represents the controlled maximum concentration in air to avoid a fire. This concentration regulates concentration buildup in recirculating ovens, exhaust piping, and other sealed containment.

Although some common solvents are unregulated from a manufacturing and occupational safety perspective, they may be regulated through an environmental release perspective. In the United States, the Department of Energy (DOE) has created protective action criteria (PAC) to determine exposure severity in the case of chemicalr release. For the chemicals listed in Table 1, their respective DOE PAC levels are listed in Table S2, Supporting Information.

In manufacturing, solvent handling is often done in atmospherically closed systems up until ink coating, where solvents vapors are released into the broader environment. This can be seen schematically in Figure 1. Exposure limits place an upper limit on human exposure, but directly translate into an upper manufacturing limit for a given facility size and air handling capacity. Because solvents are continuously evaporating during a coating process, only a limited amount of solvent can be used before factory workers are over exposed due to solvent vapors. In addition, only a limited amount of air can be extracted from a building at any given time before heating, air conditioning (HVAC) and other environmental control costs become too expensive to support. Therefore, a practical upper manufacturing limit exits based on the permissible exposure limit. We calculate this upper limit assuming a 5 µm wet film coating thickness, as previously reported, [33,34] and experimental procedures described later. We also assume a single shift 8 h working day and a 250 day working year. The end product is assumed to be a 15% peak PCE PV module. We find that the upper limit to manufacturing productivity (MW/year) for a given volume of production facility (m<sup>3</sup>) is dependent on the air exchange rate of the production facility  $(1 \, h^{-1})$  as well as the exposure limit of the solvent and its liquid molar volume (Lmol<sup>-1</sup>). We plot the material quantities versus the gross building air exchange rate in Figure 2a. Comparing dimethylformamide (DMF) and tetrahydrofuran (THF), two industrial aprotic solvents, with a modest air exchange rate of 4 exchanges per hour, we find that transitioning to a THF-based solvent system over a DMF-based system can increase the manufacturing capacity of a same-sized factory 22-fold.

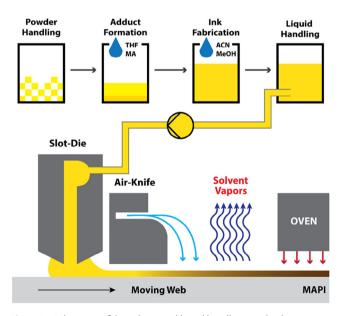
This analysis shows that working with more hazardous substances requires additional resources in the form of air handling and building capacity. We sought to determine a minimum added cost to a solution printed solar panel given this increase in operating costs (OpEx) and capital costs (CapEx) for air handling. Operating costs were estimated using air flow capacity and cost estimations provided by the U.S. Department of Energy and Environmental Protection Agency. [35] Capital costs were calculated using a constant 4 air exchanges per hour in a 3-story factory with a 10 year cost depreciation and a 15% PCE module. The facility had a nominal cost of \$5000 m<sup>-2</sup> of floor area. Additional details for the calculation can be found in the Supporting

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**Table 1.** Exposure limits dependent on source. Compiled from issuing institutions. [29–31] Units are parts-per-million (PPM). All values are time-weighted over 8 h except those identified.

Solvent <sup>a)</sup>	PEL	REL	TLV	OEL	25%LEL	Use
DMF	10	10	10	5/10 <sup>b)</sup>	5500	Solvent
ACN	40	20	40/60 <sup>b)</sup>	40/70 <sup>b)</sup>	11 000	Solvent
N-Methyl-2-pyrrolidone (NMP)	-	-	_	10/20 <sup>b)</sup>	3250	Solvent
DMSO	-	_	_	_	6500	Solvent
gamma-Butyrolactone <sup>c)</sup>	-	_	_	_	_	Solvent
Propylene carbonate	-	_	_	_	6500	Solvent
2-Methoxyethanol (2ME)	25	0.1	0.1	10	4500	Solvent
Methylamine (MA) <sup>c)</sup>	10	10	5/15 <sup>b)</sup>	_	12 250	Additive
Ethylamine	10	10	5/15 <sup>b)</sup>	5	8750	Additive
Isopropyl amine	5	_	5/10 <sup>b)</sup>	_	5000	Additive
Pyridine	5	5	1	5	4500	Additive
Chlorobenzene	75	_	10	5/15 <sup>b)</sup>	3250	Anti-solvent
Chloroform	50 <sup>d)</sup>	2	10	2	N/A	Anti-solvent
Toluene	200/300 <sup>d)</sup> 500 <sup>b)</sup>	100	20	50/100 <sup>b)</sup>	2750	Anti-solvent
Diethyl Ether	400	_	400/500 <sup>b)</sup>	100/200 <sup>b)</sup>	4750	Anti-solvent
THF	200	200/250 <sup>b)</sup>	50/100 <sup>b)</sup>	50/100 <sup>b)</sup>	5000	This study
Methanol	200	200/250 <sup>b)</sup>	200/250 <sup>b)</sup>	200	15 000	This study

a) PEL = permissible exposure limit, REL = recommended exposure limit, TLV = threshold limit value, OEL = occupational exposure limit, LEL = lower explosion limit; b) Short term exposure limit—15–30 min; c) U.S. List 1 precursors. Regulated by the U.S. FDA; d) Ceiling Limit—exposure may never go over this value.



**Figure 1.** Schematic of the solvent and liquid handling involved in coating-based manufacturing of perovskite thin films using the methods presented in this work. Powder handling and liquid handling stages are all done in atmospherically closed systems. Only after coating and subsequent drying of the ink, solvent vapors are released into the manufacturing environment.

Information. These costs, broken down by OpEx, CapEx, and total costs are plotted against the PEL can be seen in Figure 2b. For a solvent system that uses DMF as the main

component, the overall cost add is ¢0.74/W (¢0.09/W for OpEx and ¢0.65/W for CapEx). For a solvent system that uses THF, the overall cost add would be ¢0.037/W (¢0.0042/W for OpEx and ¢0.033/W for CapEx). We note that the operating cost here only includes costs for heating, cooling, and air circulation. It does not include costs for particle filtration, humidity control, and general building maintenance. Therefore, the OpEx cost may be artificially low compared with what may be required in a true manufacturing line. This analysis assumes constant exposure at the PEL over the course of the working shift. Many institutions implement safety factors of  $4\times-10\times$  to increase worker safety due to unknown and accidental variables. With a modest  $5\times$ safety factor, a DMF solvent system would add ¢3.7/W in HVAC-related costs, whereas a THF-based solvent would add ¢0.18/W. Using the SunShot 2030 sustainable module price of \$0.30/W, [36] HVAC-related expenses for a DMF-based system would account for 12.3% of the module cost and a THF-based system would account for 0.6% of the module cost using these safety factors. These costs do not include cost of solvents, cost of materials, interconnection, packaging, or tool depreciation and therefore would represent a significant added cost.

Using four air exchanges per hour as a basis and assuming a medium-sized factory building of 100 000 m³ (\$50M U.S.), we show the upper limit to manufacturing in Figure 2c. This cost is plotted alongside the slot-die low-flow limit and an estimated extended flow regime. DMF systems are highly limited by hazardous vapors despite fundamental coating speeds being much higher. For THF, coating speeds are initially limited by the low-flow limit in the laminar regime rather than hazardous vapor buildup. Using different slot die head geometry, high

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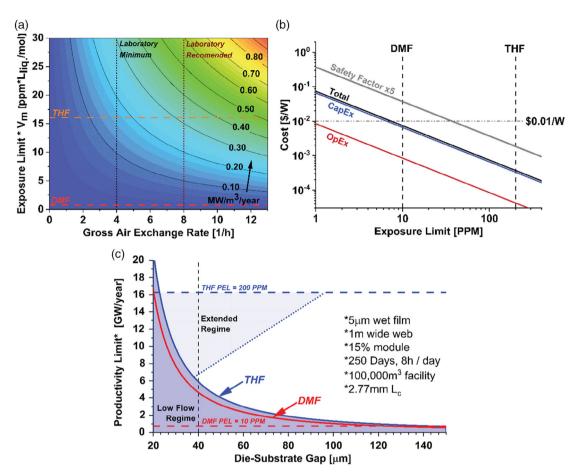


Figure 2. a) Upper manufacturing limit for a given material and the gross air exchange rate. Highlighted are the exposure limits for THF and DMF and OSHA minimum and recommended gross air exchange rates for laboratories. b) Air handling cost for a 15% PCE-printed solar module for a given permissible exposure limit. c) Slot-die microfluidic coating windows compared with productivity exposure limits for THF and DMF solvents.

coating speeds can be realized through the extended coating regime before workers hit the PEL limit.

Since exposure limits are motivated by worker safety, classes of solvents with low exposure limits should be considered more hazardous than solvents with high exposure limits. Polar aprotic solvents, small molecule amines as well as chlorinated solvents in general have low PELs and should follow caution. Alcohols and ethers in general have higher PELs. Lastly, the LELs are similar across all volatile solvents, and these values are one to two orders of magnitude above the permissible exposure limit. Therefore, if a solvent vapor is controlled to its permissible exposure limit, it will also be controlled to its fire safety limit (25% of LEL) given that there is adequate control to prevent solvent buildup in certain high-risk areas, like recirculating ovens.

#### 2.1. Engineering Safer Solvent Systems

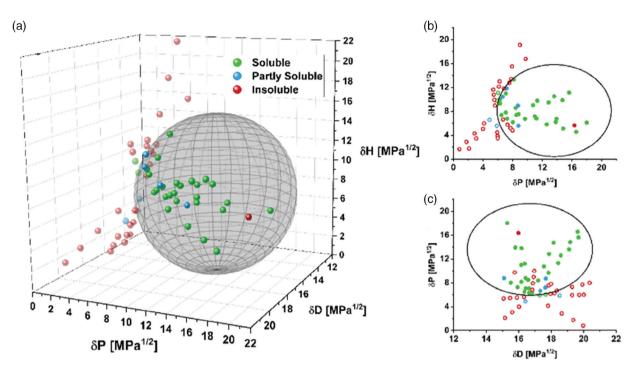
As discussed in the previous section, systems with higher permissible exposure limits allow for higher manufacturing limits, increased worker safety and lower costs. We sought to create an ink system with an overall higher exposure limit than traditional DMF systems. For this, we resort to lead—methylamine coordination complex systems that has previously been shown to

extend perovskite solubility into acetonitrile (ACN)<sup>[40]</sup> and therefore has the potential to extend solubility into other solvents. We select THF as a solvent of interest because it is a cyclic ether with a high permissible exposure limit, and has the ability to form metal complexes similar to ACN. With this system, we make a few qualitative observations. First, the ACN ink can be diluted with THF with no obvious adverse effects to crystal formation. Second, the lead–methylamine complex forms in pure THF but the complex itself is only partially soluble, creating a liquid–liquid phase separated system as seen in Figure S1, Supporting Information.

Since the THF-lead amine adduct is expected to be organic-like, we explored the solubility mechanics through the Hansen solubility model. For this, we generate the lead-methylamine adduct in THF at a high concentration and then dilute with a solvent of known Hansen parameters. We then fit this data to a traditional organic Hansen ellipsoid and extract the Hansen parameters and interaction radius. Solubility information and modeled Hansen sphere results can be seen in **Figure 3**a, and the list of solvents and experimental details seen in the Supporting Information and Table S3, Supporting Information. Fitted Hansen sphere parameters can be seen in **Table 2**. Projections of the polar and hydrogen bonding axes

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**Figure 3.** a) 3D fitted solubility sphere for the THF-MA adduct. b) Projection of the  $\delta P$  and  $\delta H$  axes. c) Projection of the  $\delta D$  and  $\delta P$  axes. Transparent or hollow points lie outside the solubility sphere.

Table 2. Fitted Hansen parameters for the Pb-methylamine-THF adduct.

Parameter	Fit
Dispersion— $\delta D$	16.69 ± 0.17
Polarity— $\delta  extbf{ extit{P}}$	$13.60\pm0.17$
Hydrogen bonding— $\delta H$	$\textbf{8.12} \pm \textbf{0.15}$
Interaction radius—R <sub>0</sub>	$\textbf{7.70} \pm \textbf{0.19}$

as seen in Figure 3b, and the dispersion and hydrogen bonding axes as seen in Figure 3c show that solubility is largely defined by solvent polarity rather than hydrogen bonding.

We take two points within the Hansen sphere and optimize both formulations for spin coated devices to demonstrate the power of the Hansen Model for predicting usable mixed solvent ink systems. For the first mixed system, we create binary mixtures of ACN and THF (THF/ACN). ACN and THF are both aprotic, and methylamine gas dissolved in THF can be sourced easily from common suppliers. Therefore, this solvent system is significantly easier to prepare than previous gas bubbling preparation methods. We then directly replace the ACN with a binary mixture of THF and methanol (THF/MeOH). After this replacement, the main solvent system is composed entirely of ether and alcohol. This binary mixture has a higher PEL of 200 ppm versus 40 ppm for pure ACN.

The morphology of the two system is shown in **Figure 4a** with more detailed analysis in Figure S2–S13, Supporting Information. Champion device current-voltage sweep from both solvent systems are shown in Figure 4b along with stabilized power output of both the systems. As shown, the two ink systems show similar performance for a n-i-p style heterojunction PV device. Stabilized power outputs of the champion cells also show

similar performance, albeit a slightly longer stabilization time is needed for the THF/MeOH ink system which may be attributed to the slightly higher hysteresis. External quantum efficiency (EQE) and calculated  $J_{\rm sc}$  is shown in Figure 4c and aligns with measured  $J_{sc}$  from J-V scans from Figure 4b. The differences between the EQE in 600-750 nm rage is attributed to thin-film interference effects resulting in minor thickness differences in the perovskite thin films (~350 nm) between ink chemistries. The THF/MeOH optimized ink also utilizes a guanidinium thiocyanate solution stabilizer to improve crystallinity and reduce hysteresis. Analysis on the ink chemistry by UV spectroscopy can be seen in Figure S11 and S12, Supporting Information. Performance of similar inks that do not use this modifier are shown in Figure S14 and S15, Supporting Information, but have similar performance characteristics. We conclude that guanidinium thiocyanate has a minor impact on ink solubility and ink chemistry, but supports lead-adduct stability when using protic solvents. This stability results in a lower defect density after coating leading to a reduced hysteresis similar to aprotic only solvent systems. In addition, due to small differences between these ink formulations, we believe both are optimizable to high performance and the modifier is not included with inks used with roll-to-roll. In addition, a comparison to a device using a DMF/dimethyl sulfoxide (DMSO) and antisolvent (AS) system is shown in Figure S17, Supporting Information.

To demonstrate the viability of these inks in a manufacturing setting, we optimized slot-die-coated devices using the THF/MeOH solvent system. Here, we choose a p-i-n-structured PV device for ease of fabrication in a roll-to-roll setting. The ink is slot-die coated onto a moving web at 1 m min<sup>-1</sup> and dried immediately with an air knife. The dried and crystalized film is passed through a 1 m oven with a temperature of 130°C, allowing

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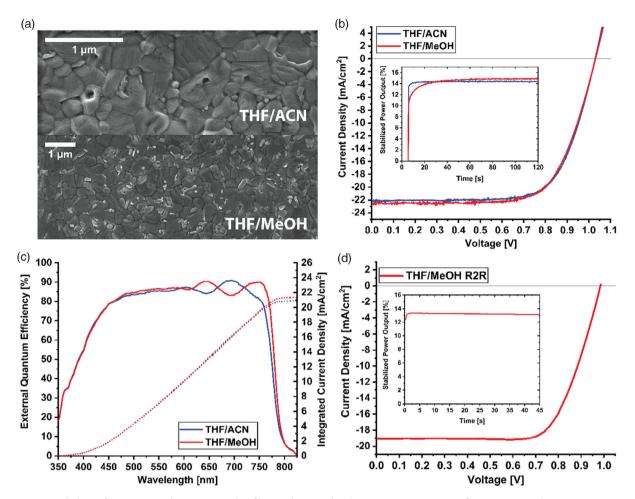


Figure 4. a) Morphology of THF/ACN and THF/MeOH thin films under SEM. b) Champion J-V comparison for THF/ACN and THF/MeOH optimized formulations and c) EQE of the same two cells. d) J-V curve for champion roll-to-roll-coated THF/MeOH device.

for only 1 min of annealing. Here, we find an average PCE of 10.5% with a champion device of 13.2%, as shown in Figure 4d. Device statistics and additional fabrication methods can be seen in Figure S17 and Table S5, Supporting Information. The cells are largely limited by high series resistance originating from higher resistivity  $50\,\Omega\,\mathrm{square^{-1}}$  indium tin oxide (ITO) on polyethylene terephthalate (PET) relative to annealed ITO on glass (15  $\Omega\,\mathrm{square^{-1}}$ ). Higher efficiency spin-coated devices with lower resistivity ITO show similar scanned performance to the n-i-p structures.

### 2.2. Exposure Limits of Mixed Solvents

The above results show that it is possible to engineer safer solvent systems using mixed solvents for Pb-methylamine adduct-based solvent systems. The U.S. OSHA defines that for mixed chemical systems that do not have additive effects, the permissible exposure can be represented by an equivalent exposure as seen in Equation (1). Here, C is the time-weighted average exposure concentration of the component and L is the exposure limit. To be compliant the equivalent exposure must be less than one.

$$E = \frac{C_1}{L_1} + \frac{C_2}{L_2} + \frac{C_n}{L_n}$$

$$E \le 1$$
(1)

Using this equivalent exposure, we can calculate an equivalent permissible exposure limit for a given mixed solvent system. For the systems discussed in this work, their equivalent PELs are listed in **Table 3**, along with more traditional systems found in literature.

In all systems, the equivalent PEL is pinned by the lowest regulated component, in this case methylamine. However, the amount is low enough that the equivalent PEL remains high,  $12 \times$  higher than DMF alone, and  $10 \times$  higher than standard

Table 3. Equivalent PEL's using USA OSHA's equivalent exposure criteria.

System	PEL-Eq	Ref	
THF/MeOH/MA	125	This work	
THF/ACN/MA	50.7	This work	
THF/ACN/MA	43.1	[41]	
ACN/MA	36.0	[40]	
DMF/DMSO	12.6	[42]	



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DMF/DMSO systems. Future work should focus on the replacement of methylamine with nontoxic ligands to further improve ink safety.

#### 3. Conclusion

This work shows the importance of lower toxicity solvents to achieve high manufacturing capacity in printed thin-film perovskite solar technologies. Hazardous solvent ink systems have lower exposure limits which restricts manufacturing capacity due to the need for additional air handling infrastructure. This additional cost can be significant, adding up to ¢3.7/W on a theoretical module of 15% PCE for a DMF-based perovskite layer. Due to this cost we demonstrate that DMF is not compatible with high-speed manufacturing and may not be economically sustainable. We engineer a lead-methylamine adduct-based solvent system and apply the Hansen solubility model to select new solvent systems with lowered toxicity. We develop two new ink systems: one system that is easier to prepare relative to similar ACN systems, as well as a new ink system composed entirely of THF and methanol. This new ink system is fast drying and easily slot-die coated. In addition, this system has a 12× higher permissible exposure limit than a traditional DMF system. We have also shown high-efficiency perovskite PV with both proof-of-concept spin coated as well as slot-die-coated device films. Overall, this work aims to provide a quantifiable framework for industry compatible solvent selection for perovskite ink development as needed for scalable perovskite PV manufacturing.

# **Supporting Information**

Supporting Information is available from the Wiley Online Library or from the author.

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#### Conflict of Interest

The authors declare no conflict of interest.

# **Data Availability Statement**

The data that support the findings of this study are available from the corresponding author upon reasonable request.

# Keywords

perovskites, roll-to-roll manufacturing, solvents, toxicity

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